



## Features

- RoHS compliant\*
- Low power loss and high efficiency
- High current capability
- Low profile package

## Applications

- AC operated products
- Computer monitors
- Set-top boxes
- Cable modems

# CD-MBL1xxS Surface Mount Bridge Rectifier Diode

## General Information

The markets of portable communications, computing and video equipment are challenging the semiconductor industry to develop increasingly smaller electronic components.

Bourns offers Bridge Rectifier Diodes for rectification applications in compact chip package 0.23 " x 0.20 " size format, which offers PCB real estate savings and are considerably smaller than standard parts. The Bridge Rectifier Diodes offer a forward current of 1 A with a choice of repetitive peak reverse voltages between 200 V and 1000 V.



## Absolute Maximum Ratings (@ T<sub>A</sub> = 25 °C Unless Otherwise Noted)

Parameter	Symbol	CD-					Unit
		MBL102S	MBL104S	MBL106S	MBL108S	MBL110S	
Maximum Repetitive Peak Reverse Voltage	V <sub>RRM</sub>	200	400	600	800	1000	V
Maximum RMS Voltage	V <sub>RMS</sub>	140	280	420	560	700	V
Maximum Average Forward Rectified Current (T <sub>A</sub> = 55 °C)	I <sub>F(AV)</sub>	1					A
Peak Forward Surge Current 8.3 ms Single Half Sine-Wave Superimposed on Rated Load (JEDEC Method)	I <sub>FSM</sub>	30					A
Operating Temperature Range	T <sub>J</sub>	-55 to +175					°C
Storage Temperature Range	T <sub>STG</sub>	-55 to +175					°C

## Electrical Characteristics (@ T<sub>A</sub> = 25 °C Unless Otherwise Noted)

Parameter	Symbol	CD-MBL1xxS			Unit	
		Test Conditions	Min.	Typ.		Max.
Instantaneous Forward Voltage	V <sub>F</sub>	I <sub>F</sub> = 1 A		0.95	1.0	V
Repetitive Peak Reverse Current	I <sub>RRM</sub>	V <sub>R</sub> = V <sub>RRM</sub>	T <sub>A</sub> = +25 °C		5.0	μA
			T <sub>A</sub> = +150 °C			200
Junction Capacitance	C <sub>J</sub>	V <sub>R</sub> = 4 V, f = 1.0 MHz		25		pF
Thermal Resistance, Junction to Air <sup>(1)</sup>	R <sub>θJA</sub>			95		°C / W
Thermal Resistance, Junction to Lead <sup>(1)</sup>	R <sub>θJL</sub>			20		°C / W

NOTE 1: Measured when mounted on PCB with 5.0 mm x 5.0 mm (0.2 " x 0.2 ") copper pad areas.

\*RoHS Directive 2002/95/EC Jan. 27, 2003 including annex and RoHS Recast 2011/65/EU June 8, 2011.

Specifications are subject to change without notice.

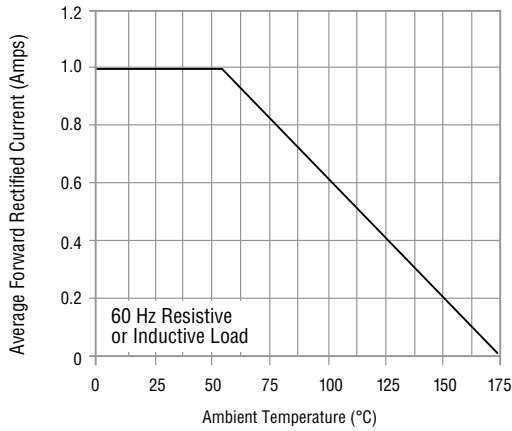
The device characteristics and parameters in this data sheet can and do vary in different applications and actual device performance may vary over time. Users should verify actual device performance in their specific applications.

# CD-MBL1xxS Surface Mount Bridge Rectifier Diode

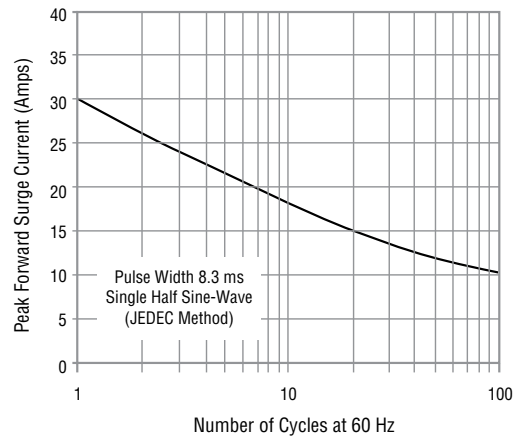


## Rating and Characteristic Curves

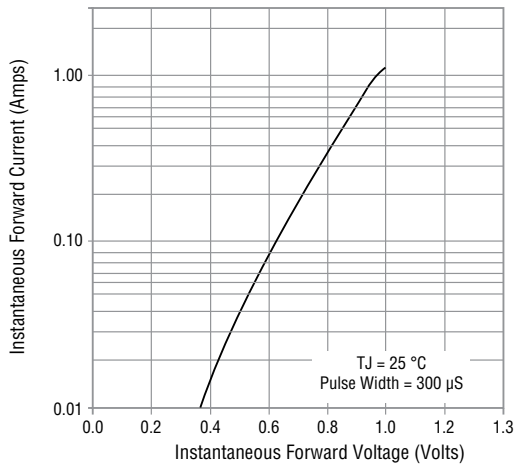
### Forward Current Derating Curve



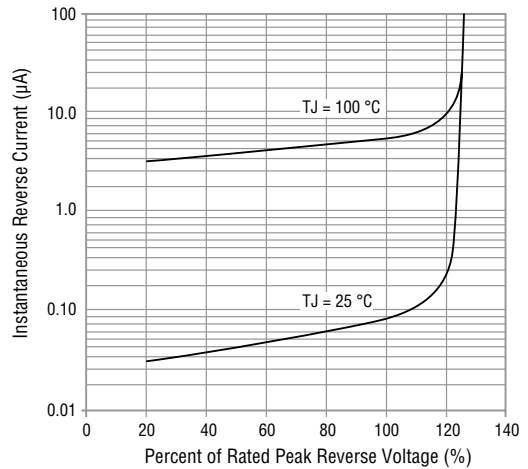
### Maximum Non-Repetitive Peak Forward Surge Current



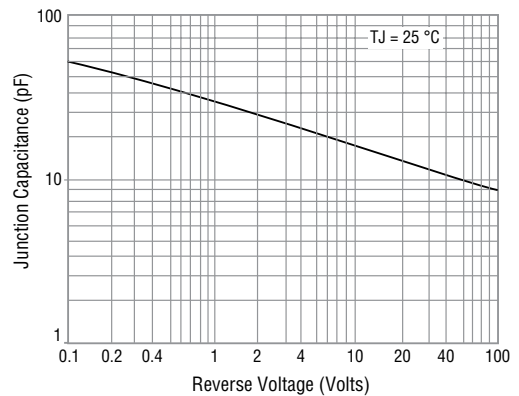
### Forward Characteristics



### Reverse Characteristics



### Typical Junction Capacitance



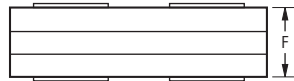
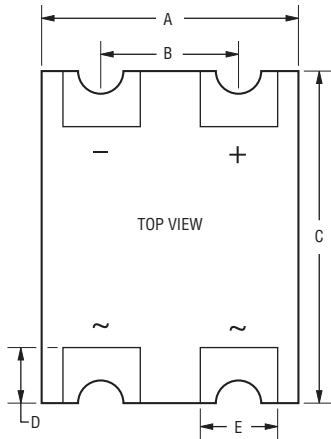
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# CD-MBL1xxS Surface Mount Bridge Rectifier Diode



## Product Dimensions

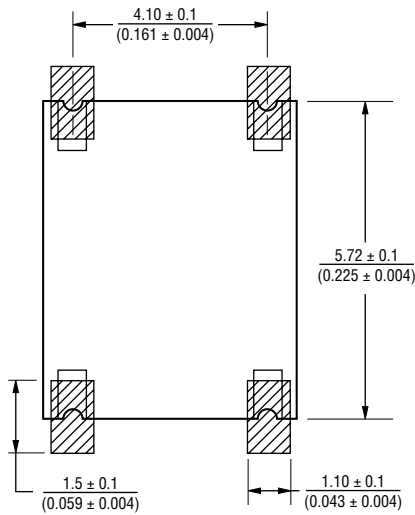
This is an RoHS2 compliant product, packaged with FRP substrate and is epoxy underfilled. The terminals are pure tin plated (lead free) and are solderable per MIL-STD-750, Method 2026. The package and dimensions are shown below.



DIMENSIONS:  $\frac{\text{MM}}{\text{(INCHES)}}$

Dimensions	
A	$\frac{5.20 - 5.40}{(0.205 - 0.213)}$
B	$\frac{4.10 - 4.30}{(0.161 - 0.169)}$
C	$\frac{5.70 - 5.90}{(0.224 - 0.232)}$
D	$\frac{1.00 - 1.20}{(0.039 - 0.047)}$
E	$\frac{0.85 - 0.95}{(0.033 - 0.037)}$
F	$\frac{0.86 - 1.16}{(0.0338 - 0.0457)}$

## Recommended Footprint



DIMENSIONS:  $\frac{\text{MM}}{\text{(INCHES)}}$

## How to Order

**CD - MBL 1 02 S**

Common Code \_\_\_\_\_  
 Chip Diode \_\_\_\_\_

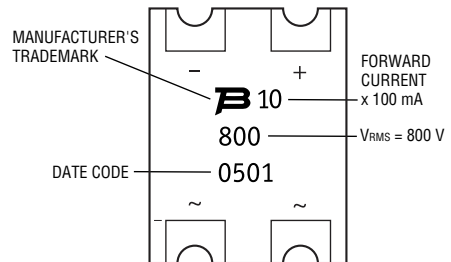
Model \_\_\_\_\_  
 MBL = MBL Bridge Series \_\_\_\_\_

Average Forward Current \_\_\_\_\_  
 1 = 1 A \_\_\_\_\_

Reverse Voltage \_\_\_\_\_  
 02 = 200 V \_\_\_\_\_  
 04 = 400 V \_\_\_\_\_  
 06 = 600 V \_\_\_\_\_  
 08 = 800 V \_\_\_\_\_  
 10 = 1000 V \_\_\_\_\_

Forward Voltage Suffix \_\_\_\_\_  
 S = Standard Forward Voltage \_\_\_\_\_

## Typical Part Marking



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# CD-MBL1xxS Surface Mount Bridge Rectifier Diode

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## Packaging Information

The surface mount product is packaged in a 12 mm x 8 mm tape and reel format per EIA-481 standard.



Item	Symbol	CD-MBL1xxS
Carrier Width	A	$\frac{5.90 \pm 0.10}{(0.232 \pm 0.004)}$
Carrier Length	B	$\frac{6.50 \pm 0.10}{(0.256 \pm 0.004)}$
Carrier Depth	C	$\frac{1.50 \pm 0.10}{(0.059 \pm 0.004)}$
Sprocket Hole	d	$\frac{1.55 \pm 0.05}{(0.061 \pm 0.002)}$
Reel Outside Diameter	D	$\frac{330}{(12.992)}$
Reel Inner Diameter	D <sub>1</sub>	$\frac{50.0}{(1.969)}$ MIN.
Feed Hole Diameter	D <sub>2</sub>	$\frac{13.0 \pm 0.20}{(0.512 \pm 0.008)}$
Sprocket Hole Position	E	$\frac{1.75 \pm 0.10}{(0.069 \pm 0.004)}$
Punch Hole Position	F	$\frac{5.50 \pm 0.05}{(0.217 \pm 0.002)}$
Punch Hole Pitch	P	$\frac{8.00 \pm 0.10}{(0.315 \pm 0.004)}$
Sprocket Hole Pitch	P <sub>0</sub>	$\frac{4.00 \pm 0.10}{(0.157 \pm 0.004)}$
Embossment Center	P <sub>1</sub>	$\frac{2.00 \pm 0.05}{(0.079 \pm 0.002)}$
Overall Tape Thickness	T	$\frac{0.20 \pm 0.10}{(0.008 \pm 0.004)}$
Tape Width	W	$\frac{12.00 \pm 0.20}{(0.472 \pm 0.008)}$
Reel Width	W <sub>1</sub>	$\frac{18.7}{(0.736)}$ MAX.
Quantity per Reel	--	5,000

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Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
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- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



#### Как с нами связаться

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